

Description

The PSMD2P06R3H uses split gate trench technology to provide excellent $R_{DS(ON)}$ low gate charge. This device is suitable for power management and high efficiency applications at high switching frequencies

MOSFET Product Summary

$V_{DS}(V)$	$R_{DS(on)}(m\Omega)$	$I_D(A)$	
60	3.2@ $V_{GS} = 10V$	Silicon Limited $T_C=25^\circ C$	158
		Silicon Limited $T_C=100^\circ C$	100
		Package Limited $T_C=25^\circ C$	100

Feature

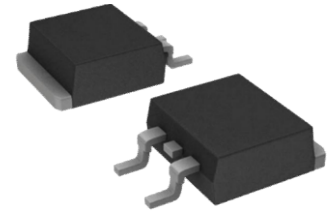
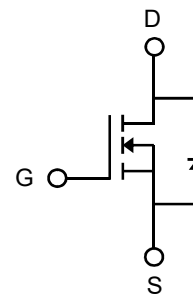
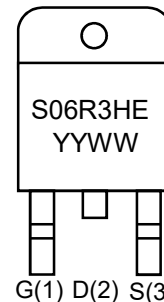
- Low $R_{DS(ON)}$ - Ensures On-State Losses are Minimized
- Excellent $Q_{gd} \times R_{DS(ON)}$ Product(FOM)
- Advanced Technology for DC-DC Converts
- Small Form Factor Thermally Efficient Package
Enables Higher Density End Products
- 100% UIS (Avalanche) Rated
- Lead-Free Finish ; RoHS Compliant
- Halogen and Antimony Free. "Green" Device

Applications

- PWM applications
- Load switch
- Power management
- DC-DC Converters
- Wireless Chargers

Absolute maximum rating@25°C

Rating		Symbol	Value	Units
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	± 20	V
Drain Current-Continuous	Silicon Limited $T_C=25^\circ C$	I_D	158	A
	Silicon Limited $T_C=100^\circ C$		100	
	Package Limited $T_C=25^\circ C$		100	
Pulsed Drain Current ¹⁾		I_{DM}	380	A
Total Power Dissipation ²⁾		P_D	92	W
Avalanche Current ⁵⁾		I_{AS}	75.5	A
Avalanche Energy ⁵⁾		E_{AS}	285	mJ
Thermal Resistance , Junction-case		$R_{\theta JC}$	1.36	$^\circ C/W$
Thermal Resistance Junction-to-Ambient @ Steady State ²⁾		$R_{\theta JA}$	43.65	$^\circ C/W$
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	$^\circ C$


TO-263 (To View)

Circuit Diagram


G(1) D(2) S(3)

Marking (Top View)

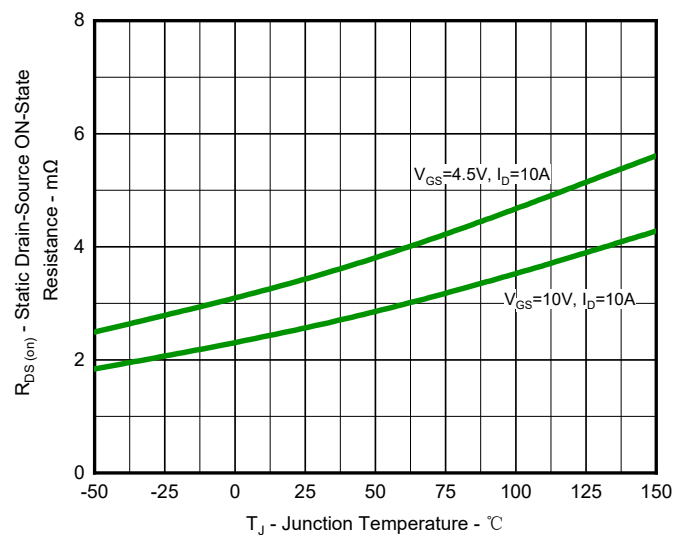
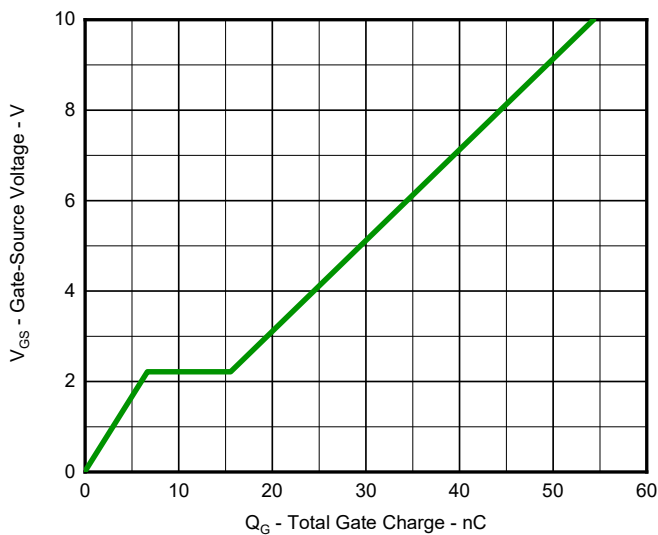
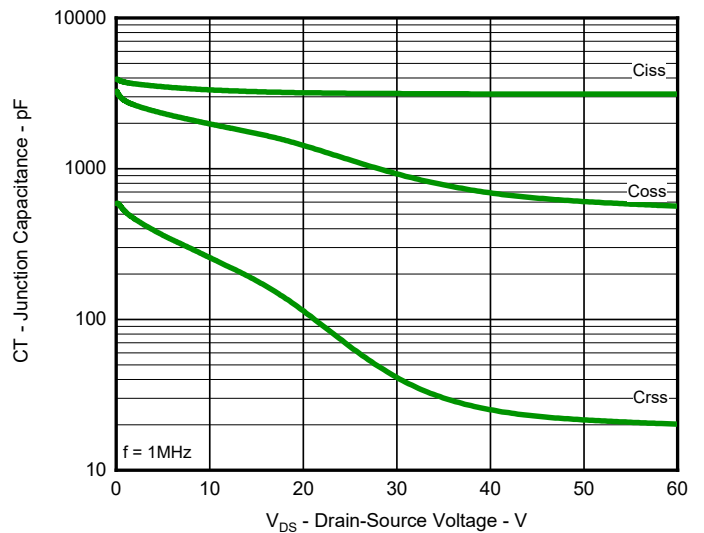
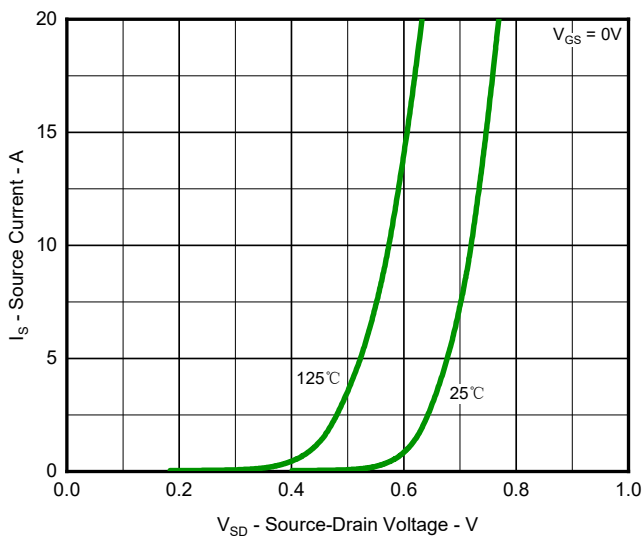
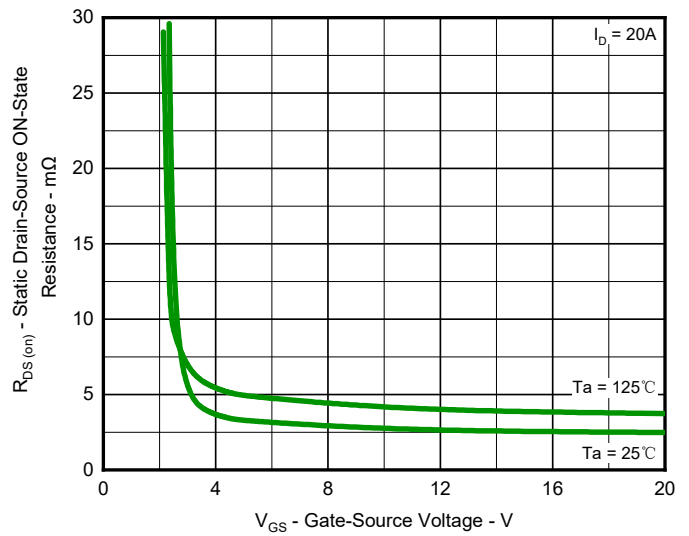
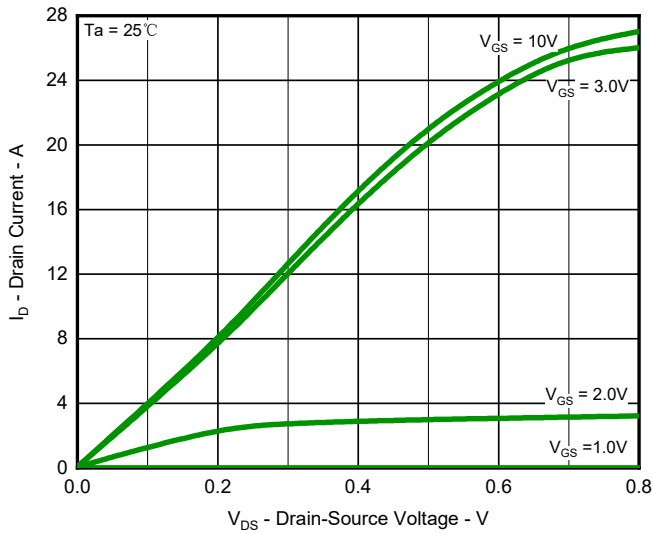
Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	60	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=60V, V_{GS}=0V$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
On Characteristics ³⁾						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	3.0	4.0	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=20A$	-	3.2	4.5	m Ω
Dynamic Parameters ⁴⁾						
Input Capacitance	C_{iss}	$V_{DS}=30V, V_{GS}=0V,$ $f=1MHz$	-	3122	-	pF
Output Capacitance	C_{oss}		-	888	-	
Reverse Transfer Capacitance	C_{rss}		-	36	-	
Switching Parameters ⁴⁾						
Turn-on Delay Time	$t_{d(on)}$	$V_{DS}=30V, V_{GS}=10V,$ $R_G=10\Omega, I_D=20A$	-	8.7	-	ns
Turn-on Rise Time	t_r		-	14.5	-	
Turn-Off Delay Time	$t_{d(off)}$		-	109.2	-	
Turn-Off Fall Time	t_f		-	46.5	-	
Total Gate Charge	Q_g	$V_{DS}=30V, I_D=20A,$ $V_{GS}=10V$	-	54.2	-	nC
Gate-Source Charge	Q_{gs}		-	6.7	-	
Gate-Drain Charge	Q_{gd}		-	8.9	-	
Gate Resistance	R_g	$V_{GS}=0V, V_{DS}=0V, f=1MHz$	-	1.36	-	Ω
Drain-Source Diode Characteristics						
Diode Forward Voltage ³⁾	V_{SD}	$V_{GS}=0V, I_S=20A$	-	0.83	1.1	V

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production.
5. This single-pulse measurement was taken under the following condition ($L=100\mu H, V_{GS}=10V, V_{DS}=50V$) while its value is limited by $T_{J,Max}=150^\circ C$.

Typical Characteristics



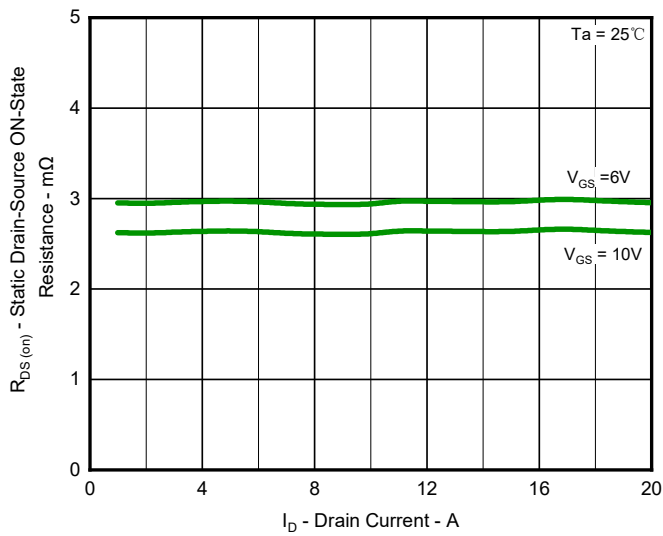


Fig.7 Typical On-Resistance vs Drain Current

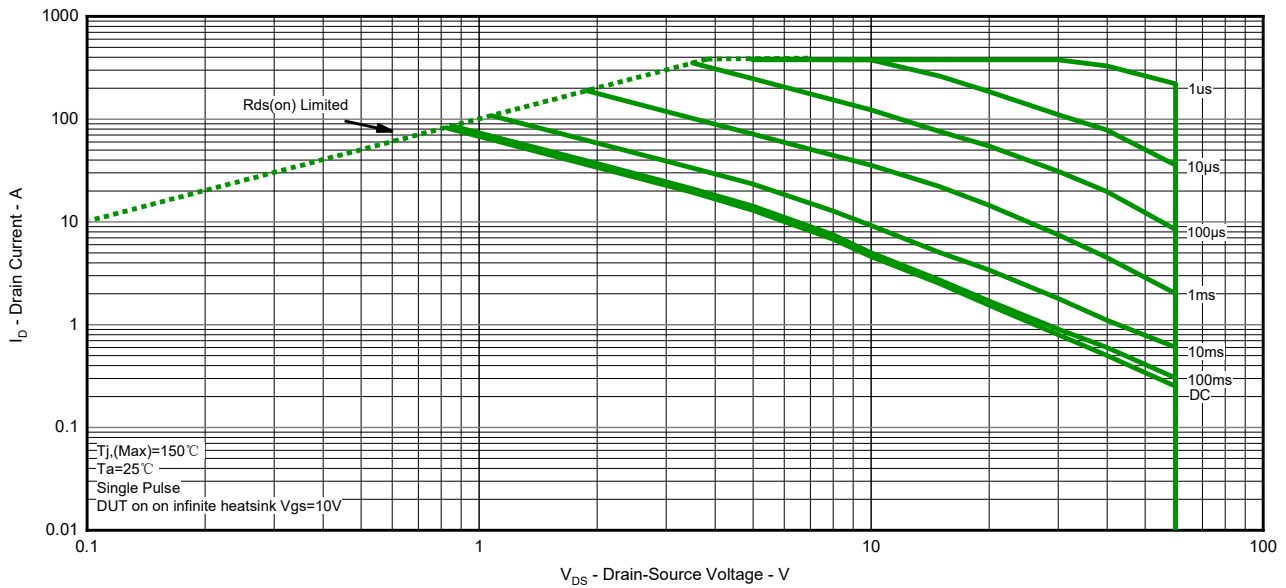


Fig.8 Safe Operation Area

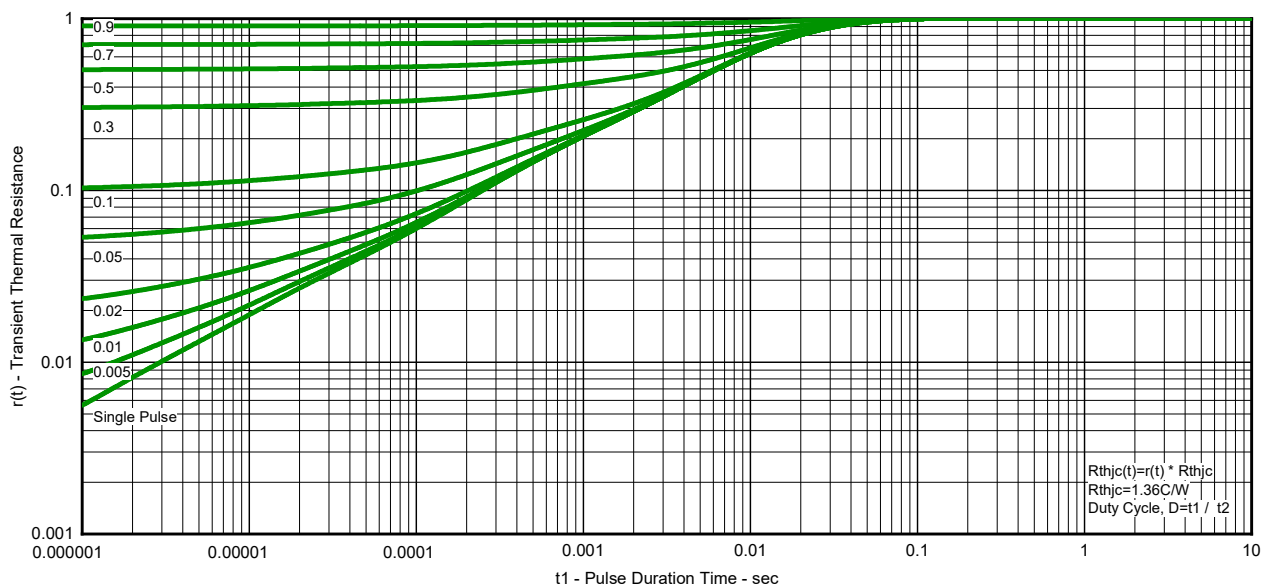
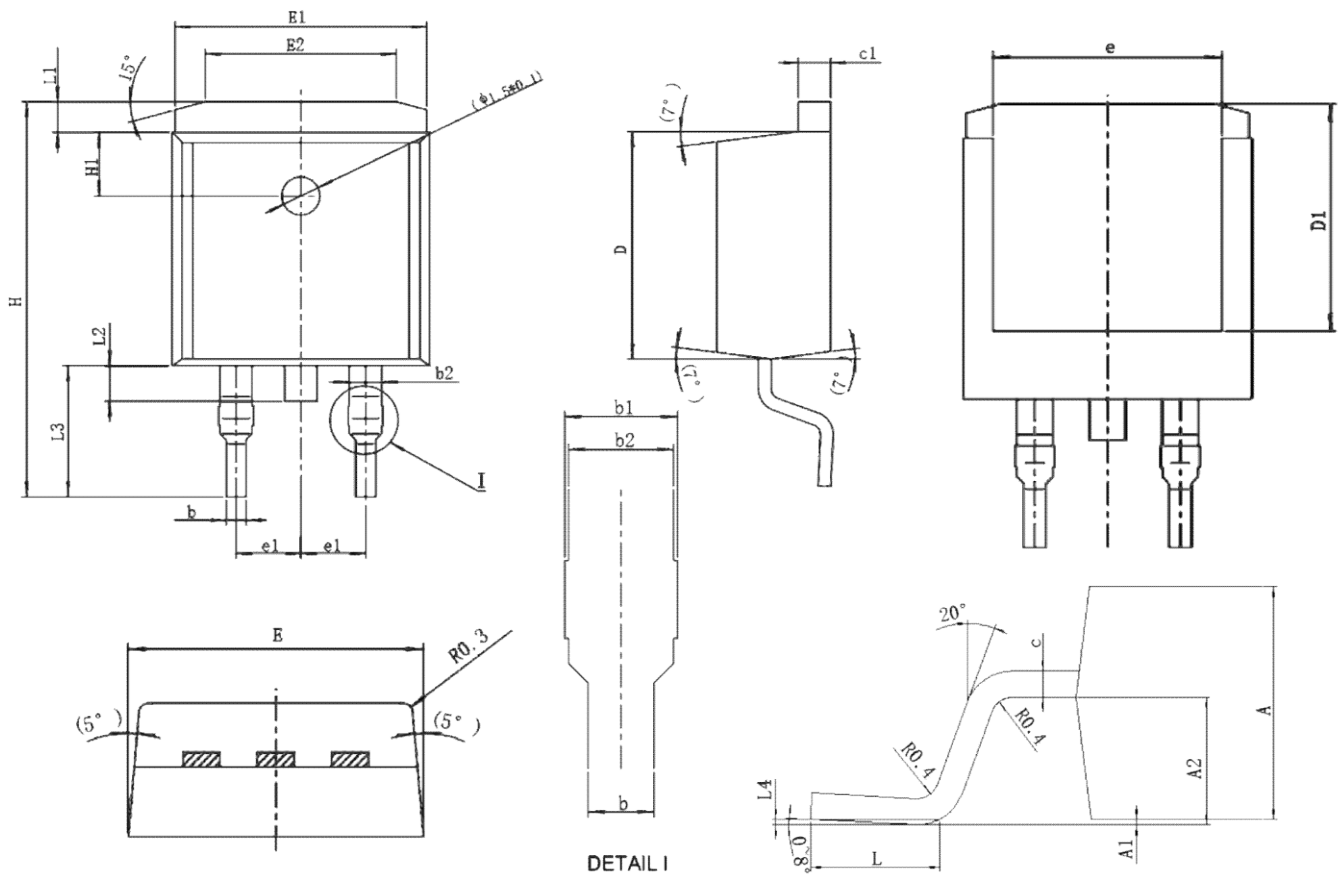



Fig.9 Transient Thermal Resistance

Product Dimension (TO-263)



Dim	Millimeters		Inches		Dim	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
A	4.56	4.58	0.180	0.180	E1	9.85	9.91	0.388	0.390
A1	0.02	0.22	0.001	0.009	E2	7.40	7.60	0.291	0.299
A2	2.34	2.67	0.092	0.105	e	7.50	8.50	0.295	0.335
b	0.75	0.85	0.030	0.033	e1	2.53	2.55	0.100	0.100
b1	1.27	1.47	0.050	0.058	H	15.30	15.70	0.602	0.618
b2	1.22	1.32	0.048	0.052	H1	2.40	2.60	0.094	0.102
c	0.51	0.53	0.020	0.021	L	2.44	2.64	0.096	0.104
c1	1.29	1.32	0.051	0.052	L1	1.10	1.30	0.043	0.051
D	9.14	9.16	0.360	0.361	L2	1.20	1.70	0.047	0.067
D1	7.93	7.95	0.312	0.313	L3	5.14	5.16	0.202	0.203
E	10.00	10.20	0.394	0.402	L4	0.11	0.13	0.004	0.005


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